

IC for Human Body Detector

Amplifier for Pyroelectric Infrared Sensor

BD9251FV

No.11096EAT01

Description

BD9251FV is used for the human body detection application.

Make to single-chip, easy to use then before. Power-saving in the best design.

Reduce the standby power requirement of the device used always. Don't choose the mounting place by a space-saving.

Features

- 1) Amplifier for sensor output
- 2) Comparator for sensor output
- 3) Built-in voltage regulator
- 4) Built-in moving detector

Applications

Lighting, Sensor Light, Security system, WEB camera, TV, PC display, Air Conditioner, Ventilation fan

●Absolute Maximum Ratings (Ta=25°C)

Parameter	Symbol	Ratings	Units
Supply Voltage	V _{DD}	-0.3~7.0	V
Power Dissipation	Pd	440 ^{×1}	mW
Operating Temperature	T _{opr}	-30~75	°C
Storage Temperature	T _{stg}	-55~125	°C

※1. It reduces 3.5mW/°C then Ta≥25°C. (On glass epoxy board of 70mm×70mm×1.6mm)

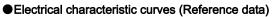
Operating Conditions

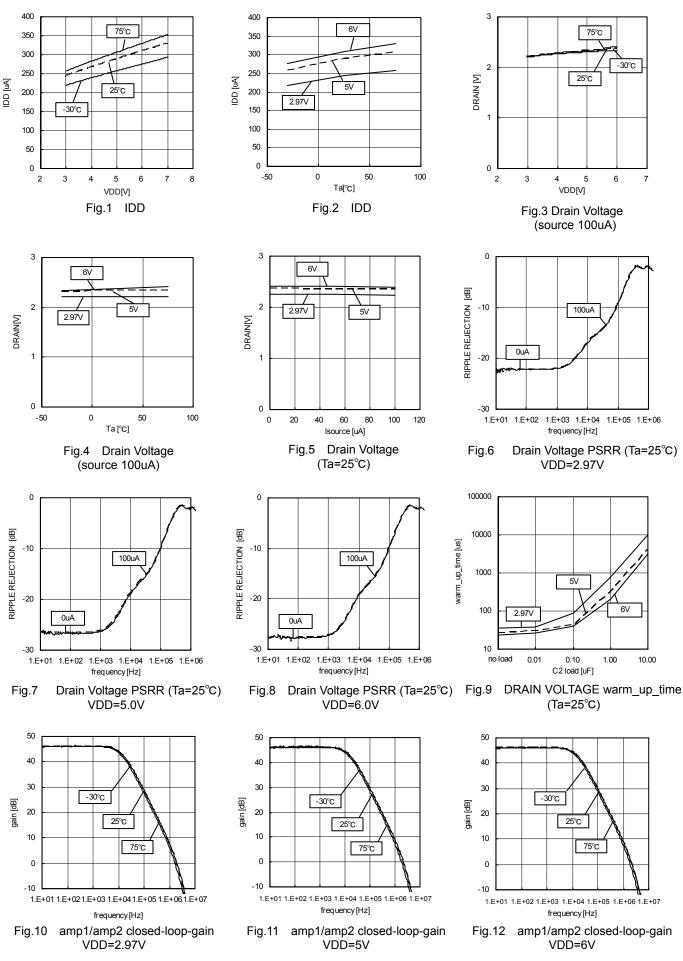
Parameter	Symbol	Ratings			Units	Conditions
Falameter		Min.	Тур.	Max.	UTILS	Conditions
Supply Voltage	V _{DD}	2.97	5.0	6.0	V	
A1P_IN Offset Voltage	VA1P_IN_OFFSET	-	1.5	-	V	V _{DRAIN} =2.3V

This product doesn't design for protection radioactive rays.

●Electric Characteristics (VDD=5.0V, Ta=25°C)

Parameter	Symbol	Limits		Units	Conditions	
	Symbol	Min.	Тур.	Max.	Units	Conditions
Supply Current	I _{DD}	-	300	400	uA	Output no load
DRAIN Output Voltage	V _{DRAIN}	2.0	2.3	-	V	VDD≧2.97V, I _{DRAIN} ≦100µA
AMP1/AMP2 Input Voltage	V _{IN}	0.1	-	V _{DD} -0.8	V	
AMP1/AMP2 Gain	A _G	-	-	46	dB	
AMP1/AMP2 Unity Gain	A _{UG}	-	1	-	MHz	
AMP1 Input Offset Voltage	V _{A10FF}	-	-	10	mV	
AMP2 Output Offset Voltage	V _{A2OUT}	-	1.5	-	V	
A2_OUT Output Current (source)	I _{A2OUT1}	20	30	-	μA	
A2_OUT Output Current (sink)	I _{A2OUT2}	20	200	-	μA	
D_OUT / T_OUT Output "H" Voltage	V _{OH}	V _{DD} -0.6	-	V _{DD}	V	I _{OH} =-1mA
D_OUT / T_OUT Output "L" Voltage	V _{OL}	0	-	0.6	V	I _{OL} =+1mA





75℃

6

75°C

6

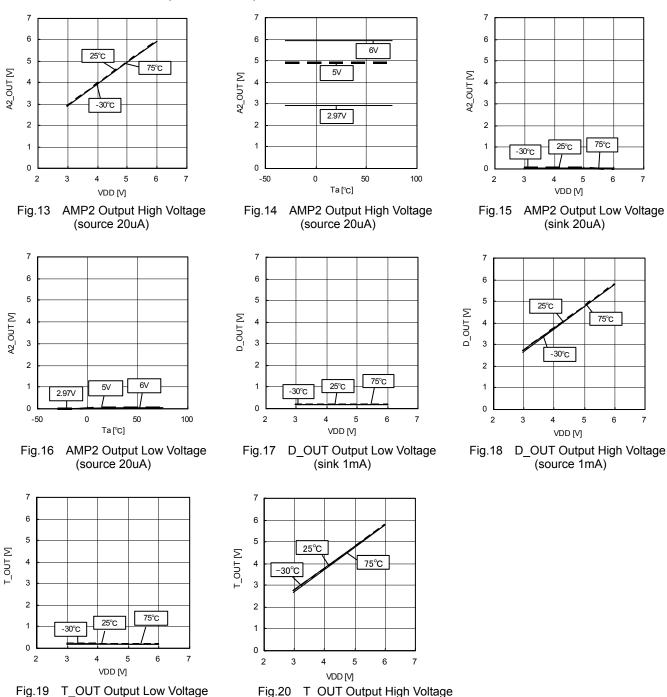
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5

7

5

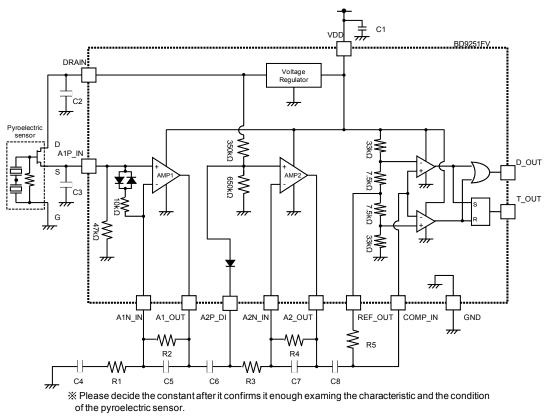
• Electrical characteristic curves (Reference data) - Continued



(sink 1mA)

(source 1mA)

Block Diagram/Application



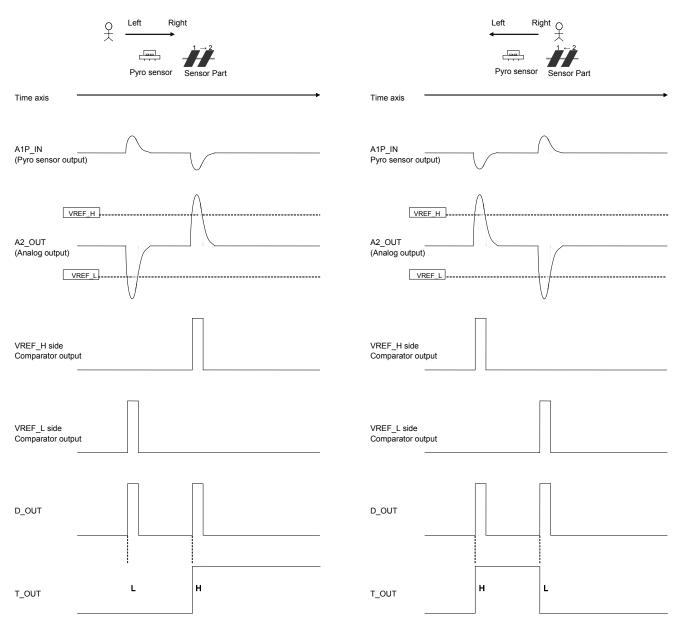


C1=C2=C3	: 1uF	R1=R3	: 47kΩ					
C4=C6	: 6.9uF	R2=R4	: 4.7MΩ					
C5=C7	: 15nF	R5	: 220kΩ					
C8	: 10uF							

PIN Description

PIN No.	PIN Name	Function	Remarks
1	GND	Ground	
2	NC	NC	
3	DRAIN	Power supply for pyroelectric infrared sensor	
4	A1P_IN	Sensor input	
5	A1N_IN	Amp1 n-input	
6	A1_OUT	Amp1 output	
7	A2P_DI	Amp2 diode output	
8	A2N_IN	Amp2 n-input	
9	A2_OUT	Amp2 output, Analog output	
10	REF_OUT	Reference voltage (1/2VDD) output	
11	COMP_IN	Comparator input	
12	D_OUT	Comparator output	
13	T_OUT	Moving detection output	
14	VDD	Power supply	

•Timing chart (When using dual type pyro sensor)



When using dual type pyro sensor, it's possible to detect the direction of movement by checking the switch of T_out signal at D_out=H.

Notes for use

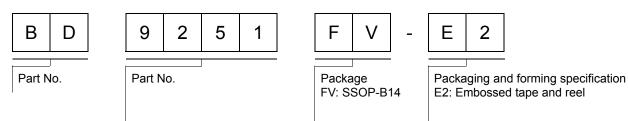
(1) Absolute maximum ratings

Use of the IC in excess of absolute maximum ratings such as the applied voltage or operating temperature range may result in IC damage. Assumptions should not be made regarding the state of the IC (short mode or open mode) when such damage is suffered. A physical safety measure such as a fuse should be implemented when use of the IC in a special mode where the absolute maximum ratings may be exceeded is anticipated.

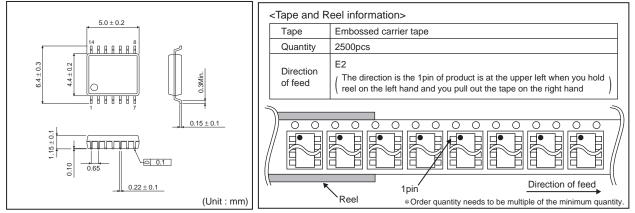
(2) GND potential Ensure a minimum GND pin potential in all operating conditions.

- (3) Short circuit mode between terminals and wrong mounting In order to mount the IC on a set PCB, pay thorough attention to the direction and offset of the ICs. Erroneous mounting can destroy the IC. Furthermore, if a short circuit occurs due to foreign matters entering between terminals or between the terminal and the power supply or the GND terminal, the IC can destroy.
- (4) Actions in strong magnetic field Use caution when using the IC in the presence of a strong magnetic field as doing so may cause the IC to malfunction.
- (5) Mutual impedance Use short and wide wiring tracks for the power supply and ground to keep the mutual impedance as small as possible .Use a capacitor to keep ripple to a minimum.
- (6) About warm-up time Operation depends on a power-supply voltage and an external constant for time until stabilizing. Please confirm warm-up time enough when you use it.
- (7) PCB design considerations To reduce the noise from OUTPUT to INPUT, COMP_IN(11pin) and D_OUT(12pin) and T_OUT(13pin) lines away from Pyro Sensor and A1P_IN(4pin).

Ordering part number



SSOP-B14



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CLASSⅢ		CLASS II b	
CLASSⅣ	CLASSⅢ	CLASSⅢ	CLASSII

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 - [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
 - [C] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation (Pd) depending on Ambient temperature (Ta). When used in sealed area, confirm the actual ambient temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

Precaution for Mounting / Circuit board design

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used; if flow soldering method is preferred, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

Precautions Regarding Application Examples and External Circuits

- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
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Precaution for Electrostatic

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

Precaution for Storage / Transportation

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
 - [a] the Products are exposed to sea winds or corrosive gases, including Cl2, H2S, NH3, SO2, and NO2
 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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QR code printed on ROHM Products label is for ROHM's internal use only.

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